

. :eescale Semiconductor

Technical Data

Document Number: AFT09MS007N Rev. 1, 4/2014

√RoHS

RF Power LDMOS Transistor

High Ruggedness N-Channel Enhancement-Mode Lateral MOSFET

Designed for handheld two-way radio applications with frequencies from 136 to 941 MHz. The high gain, ruggedness and wideband performance of this device makes it ideal for large-signal, common-source amplifier applications in handheld radio equipment.

Narrowband Performance (7.5 Vdc, $I_{DQ} = 100$ mA, $T_A = 25$ °C, CW)

| Frequency | G _{ps} | η _D | P _{out} |
|-----------|-----------------|----------------|------------------|
| (MHz) | (dB) | (%) | (W) |
| 870 (1) | 15.2 | 71.0 | 7.3 |

Wideband Performance (7.5 Vdc, T_A = 25°C, CW)

| Frequency (MHz) | P _{in} (W) | G _{ps} (dB) | η _D (%) | P _{out} (W) |
|----------------------|------------------------|-------------------------|-----------------------|-------------------------|
| 136–174 | 0.25 | 14.6 | 69.0 | 7.2 |
| 350-470 (2,5) | 0.20 | 15.6 | 60.9 | 7.3 |
| 450–520 (3,5) | 0.22 | 15.4 | 56.0 | 7.5 |
| 760–860 (4,5) | 0.23 | 15.1 | 48.1 | 7.5 |

Load Mismatch/Ruggedness

| Frequency (MHz) | Signal Type | VSWR | P _{in} (W) | Test Voltage | Result |
|--------------------|----------------|-------------------------------|-------------------------|-----------------|--------------------------|
| 870 (1) | CW | > 65:1 at all Phase Angles | 0.4 (3 dB Overdrive) | 10.8 | No Device Degradation |

- 1. Measured in 870 MHz narrowband test circuit.
- 2. Measured in 350-470 MHz UHF broadband reference circuit.
- 3. Measured in 450-520 MHz UHF broadband reference circuit.
- 4. Measured in 760-860 MHz UHF broadband reference circuit.
- The values shown are the minimum measured performance numbers across the indicated frequency range.

Features

- · Characterized for Operation from 136 to 941 MHz
- Unmatched Input and Output Allowing Wide Frequency Range Utilization
- Integrated ESD Protection
- Integrated Stability Enhancements
- · Wideband Full Power Across the Band
- · Exceptional Thermal Performance
- · Extreme Ruggedness
- · High Linearity for: TETRA, SSB
- In Tape and Reel. T1 Suffix = 1,000 Units, 16 mm Tape Width, 7-inch Reel.

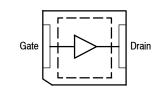
Typical Applications

- Output Stage VHF Band Handheld Radio
- · Output Stage UHF Band Handheld Radio
- Output Stage for 700–800 MHz Handheld Radio

AFT09MS007NT1

136–941 MHz, 7 W, 7.5 V WIDEBAND RF POWER LDMOS TRANSISTOR





Note: The center pad on the backside of the package is the source terminal for the transistor.

Figure 1. Pin Connections





Table 1. Maximum Ratings

| Rating | Symbol | Value | Unit |
|---|------------------|-------------|-----------|
| Drain-Source Voltage | V _{DSS} | -0.5, +30 | Vdc |
| Gate-Source Voltage | V _{GS} | -6.0, +12 | Vdc |
| Operating Voltage | V _{DD} | 12.5, +0 | Vdc |
| Storage Temperature Range | T _{stg} | -65 to +150 | °C |
| Case Operating Temperature Range | T _C | -40 to +150 | °C |
| Operating Junction Temperature (1,2) | TJ | -40 to +150 | °C |
| Total Device Dissipation @ T _C = 25°C Derate above 25°C | P _D | 114 0.91 | W W/°C |

Table 2. Thermal Characteristics

| Characteristic | Symbol | Value ^(2,3) | Unit |
|--|----------------|------------------------|------|
| Thermal Resistance, Junction to Case Case Temperature 74°C, 7 W CW, 7.5 Vdc, I _{DQ} = 100 mA, 870 MHz | $R_{	heta JC}$ | 1.1 | °C/W |

Table 3. ESD Protection Characteristics

| Test Methodology | Class |
|---------------------------------------|-------------------|
| Human Body Model (per JESD22-A114) | 2, passes 2500 V |
| Machine Model (per EIA/JESD22-A115) | B, passes 200 V |
| Charge Device Model (per JESD22-C101) | IV, passes 2000 V |

Table 4. Moisture Sensitivity Level

| | Test Methodology | Rating | Package Peak Temperature | Unit |
|---|--------------------------------------|--------|--------------------------|------|
| Ī | Per JESD22-A113, IPC/JEDEC J-STD-020 | 3 | 260 | °C |

Table 5. Electrical Characteristics (T_A = 25°C unless otherwise noted)

| Characteristic | Symbol | Min | Тур | Max | Unit |
|--|------------------|-----|-----|-----|------|
| Off Characteristics | | | | | |
| Zero Gate Voltage Drain Leakage Current (V _{DS} = 30 Vdc, V _{GS} = 0 Vdc) | I _{DSS} | _ | _ | 10 | μAdc |
| Zero Gate Voltage Drain Leakage Current (V _{DS} = 7.5 Vdc, V _{GS} = 0 Vdc) | I _{DSS} | _ | _ | 2 | μAdc |
| Gate-Source Leakage Current (V _{GS} = 5 Vdc, V _{DS} = 0 Vdc) | I _{GSS} | _ | _ | 1 | nAdc |
| On Characteristics | | | | | |
| 0 . = | | | | | |

| Gate Threshold Voltage ($V_{DS} = 10 \text{ Vdc}, I_D = 110 \mu \text{Adc}$) | V _{GS(th)} | 1.6 | 2.1 | 2.6 | Vdc |
|---|---------------------|-----|------|-----|-----|
| Drain-Source On-Voltage $(V_{GS} = 10 \text{ Vdc}, I_D = 1.1 \text{ Adc})$ | V _{DS(on)} | _ | 0.12 | _ | Vdc |
| Forward Transconductance (V _{DS} = 7.5 Vdc, I _D = 3 Adc) | 9fs | _ | 9.8 | _ | S |

Dynamic Characteristics

| Reverse Transfer Capacitance (V _{DS} = 7.5 Vdc ± 30 mV(rms)ac @ 1 MHz, V _{GS} = 0 Vdc) | C _{rss} | _ | 2.7 | _ | pF |
|--|------------------|---|-----|---|----|
| Output Capacitance (V _{DS} = 7.5 Vdc ± 30 mV(rms)ac @ 1 MHz, V _{GS} = 0 Vdc) | C _{oss} | _ | 56 | _ | pF |
| Input Capacitance (V _{DS} = 7.5 Vdc, V _{GS} = 0 Vdc ± 30 mV(rms)ac @ 1 MHz) | C _{iss} | _ | 107 | _ | pF |

- 1. Continuous use at maximum temperature will affect MTTF.
- 2. MTTF calculator available at http://www.freescale.com/rf. Select Software & Tools/Development Tools/Calculators to access MTTF calculators by product.
- 3. Refer to AN1955, *Thermal Measurement Methodology of RF Power Amplifiers.* Go to http://www.freescale.com/rf. Select Documentation/Application Notes AN1955.

(continued)



Table 5. Electrical Characteristics ($T_A = 25^{\circ}C$ unless otherwise noted) (continued)

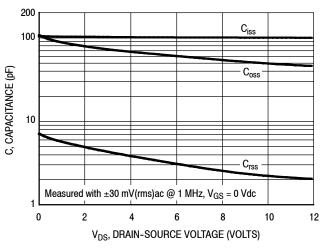
| Characteristic | Symbol | Min | Тур | Max | Unit | |
|--|------------------|-----|------|-----|------|--|
| Functional Tests (In Freescale Test Fixture, 50 ohm system) V _{DD} = 7.5 Vdc, I _{DQ} = 100 mA, P _{in} = 0.22 W, f = 870 MHz | | | | | | |
| Common-Source Amplifier Output Power | P _{out} | _ | 7.3 | _ | W | |
| Drain Efficiency | η _D | _ | 71.0 | _ | % | |

 $\textbf{Load Mismatch/Ruggedness} \text{ (In Freescale Test Fixture, 50 ohm system) } \textbf{I}_{DQ} = 100 \text{ mA}$

| Frequency (MHz) | Signal Type | VSWR | P _{in} (W) | Test Voltage, V _{DD} | Result |
|--------------------|----------------|----------------------------|-------------------------|-------------------------------|-----------------------|
| 870 | CW | > 65:1 at all Phase Angles | 0.4 (3 dB Overdrive) | 10.8 | No Device Degradation |



TYPICAL CHARACTERISTICS



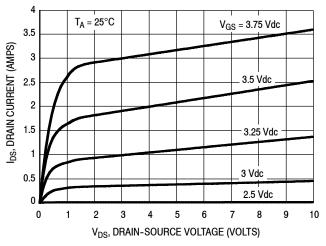
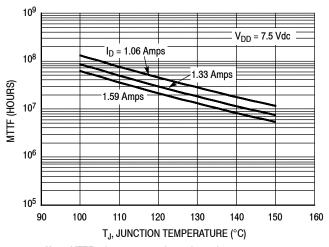


Figure 2. Capacitance versus Drain-Source Voltage

Figure 3. Drain Current versus Drain-Source Voltage



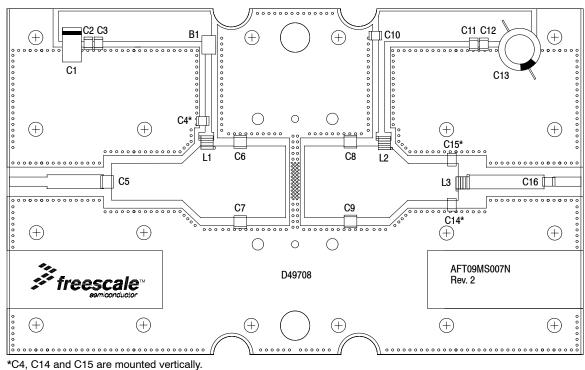
Note: MTTF value represents the total cumulative operating time under indicated test conditions.

MTTF calculator available at http://www.freescale.com/rf. Select Software & Tools/Development Tools/Calculators to access MTTF calculators by product.

Figure 4. MTTF versus Junction Temperature — CW



870 MHz NARROWBAND PRODUCTION TEST FIXTURE



04, 014 and 013 are mounted vertically.

Figure 5. AFT09MS007NT1 Narrowband Test Circuit Component Layout — 870 MHz

Table 6. AFT09MS007NT1 Narrowband Test Circuit Component Designations and Values — 870 MHz

| Part | Description | Part Number | Manufacturer |
|--------------|---|----------------------|--------------|
| B1 | RF Bead, Short | 2743019447 | Fair-Rite |
| C1 | 22 μF, 35 V Tantalum Capacitor | T491X226K035AT | Kemet |
| C2, C12 | 0.1 μF Chip Capacitors | CDR33BX104AKWS | Kemet |
| C3, C11 | 0.01 μF Chip Capacitors | C0805C103K5RAC | Kemet |
| C4, C10, C16 | 56 pF Chip Capacitors | ATC100B560CT500XT | ATC |
| C5 | 3.9 pF Chip Capacitor | ATC100B3R9CT500XT | ATC |
| C6, C7 | 7.5 pF Chip Capacitors | ATC100B7R5CT500XT | ATC |
| C8, C9 | 6.8 pF Chip Capacitors | ATC100B6R8CT500XT | ATC |
| C13 | 330 μF, 35 V Electrolytic Capacitor | MCGPR35V337M10X16-RH | Multicomp |
| C14, C15 | 3.6 pF Chip Capacitors | ATC100B3R6CT500XT | ATC |
| L1 | 8.0 nH Inductor | A03TKLC | Coilcraft |
| L2 | 18.5 nH Inductor | A05TKLC | Coilcraft |
| L3 | 5.0 nH Inductor | A02TKLC | Coilcraft |
| PCB | Rogers RO4350B, 0.030", ε _r = 3.66 | D49708 | MTL |



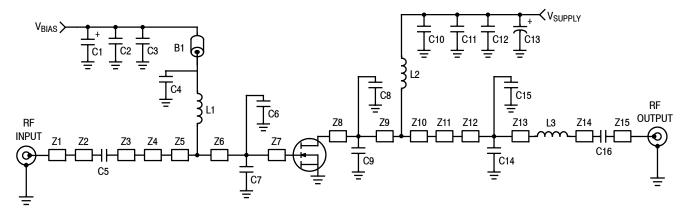


Figure 6. AFT09MS007NT1 Narrowband Test Circuit Schematic — 870 MHz

Table 7. AFT09MS007NT1 Narrowband Test Circuit Microstrips — 870 MHz

| Microstrip | Description | | | | |
|------------|--------------------------------|--|--|--|--|
| Z1 | 0.328" × 0.080" Microstrip | | | | |
| Z2 | 0.490" × 0.120" Microstrip | | | | |
| Z3 | 0.610" × 0.320" Microstrip | | | | |
| Z4 | 0.160" × 0.320" × 0.620" Taper | | | | |
| Z5 | 0.058" × 0.620" Microstrip | | | | |
| Z6 | 0.288" × 0.620" Microstrip | | | | |
| Z7 | 0.394" × 0.620" Microstrip | | | | |
| Z8 | 0.398" × 0.620" Microstrip | | | | |

| Microstrip | Description |
|------------|--------------------------------|
| Z 9 | 0.295" × 0.620" Microstrip |
| Z10 | 0.046" × 0.620" Microstrip |
| Z11 | 0.159" × 0.620" × 0.320" Taper |
| Z12 | 0.379" × 0.320" Microstrip |
| Z13 | 0.055" × 0.320" Microstrip |
| Z14 | 0.665" × 0.120" Microstrip |
| Z15 | 0.238" × 0.080" Microstrip |



TYPICAL CHARACTERISTICS — 870 MHz

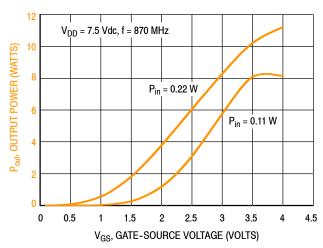


Figure 7. Output Power versus Gate-Source Voltage at a Constant Input Power

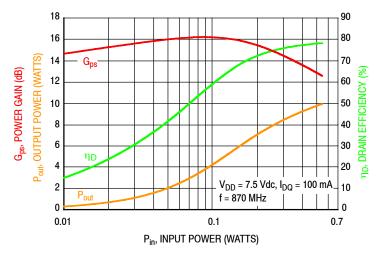


Figure 8. Power Gain, Output Power and Drain Efficiency versus Input Power

| V _{DD} = 7.5 Vdc, I _{DQ} = 100 mA, P _{out} = 7 W | | | | | | |
|---|-------------------------|------------------------|--|--|--|--|
| f MHz | $Z_{source} \ \ \Omega$ | Z _{load} Ω | | | | |
| 870 | 0.54 + j1.35 | 1.31 + j1.93 | | | | |
| Z _{source} = Test circuit impedance as measured from gate to ground. | | | | | | |

 $Z_{load} \quad = \mbox{ Test circuit impedance as measured from} \\ \quad drain to ground.$

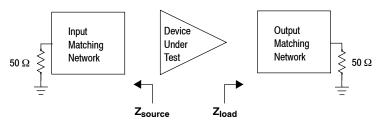


Figure 9. Narrowband Series Equivalent Source and Load Impedance — 870 MHz



350-470 MHz UHF BROADBAND REFERENCE CIRCUIT

 $\begin{tabular}{ll} \textbf{Table 8. 350-470 MHz UHF Broadband Performance} & \textbf{In Freescale Reference Circuit}, 50 ohm system) \\ \textbf{V}_{DD} = 7.5 \ \textbf{Vdc}, \ \textbf{I}_{DQ} = 200 \ \textbf{mA}, \ \textbf{T}_{A} = 25 \ \textbf{^{\circ}C}, \ \textbf{CW} \\ \end{tabular}$

| Frequency (MHz) | P _{in} (W) | G _{ps} (dB) | η _D (%) | P _{out} (W) |
|--------------------|------------------------|-------------------------|-----------------------|-------------------------|
| 350 | 0.15 | 16.6 | 60.9 | 7.3 |
| 410 | 0.15 | 16.6 | 66.5 | 7.3 |
| 470 | 0.20 | 15.6 | 70.1 | 7.3 |

Table 9. Load Mismatch/Ruggedness (In Freescale Reference Circuit)

| Frequency (MHz) | Signal Type | VSWR | P _{in} (W) | Test Voltage, V _{DD} | Result |
|--------------------|----------------|-------------------------------|-------------------------|-------------------------------|--------------------------|
| 470 | CW | > 65:1 at all Phase Angles | 0.4 (3 dB Overdrive) | 10.8 | No Device Degradation |



350-470 MHz UHF BROADBAND REFERENCE CIRCUIT

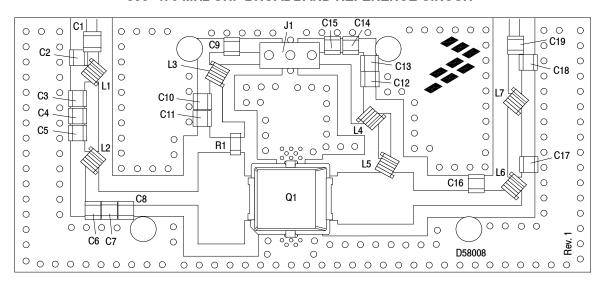


Figure 10. AFT09MS007NT1 UHF Broadband Reference Circuit Component Layout — 350-470 MHz

Table 10. AFT09MS007NT1 UHF Broadband Reference Circuit Component Designations and Values — 350-470 MHz

| Part | Description | Part Number | Manufacturer |
|--------------|---|---------------------|--------------|
| C1, C10, C19 | 100 pF Chip Capacitors | ATC600F101JT250XT | ATC |
| C2 | 10 pF Chip Capacitor | ATC600F100JT250XT | ATC |
| C3 | 3.0 pF Chip Capacitor | ATC600F3R0BT250XT | ATC |
| C4, C8 | 27 pF Chip Capacitors | ATC600F270JT250XT | ATC |
| C5 | 5.1 pF Chip Capacitor | ATC600F5R1BT250XT | ATC |
| C6, C7 | 30 pF Chip Capacitors | ATC600F300JT250XT | ATC |
| C9 | 10 nF Chip Capacitor | C1210C103J5GAC-TU | Kemet |
| C11 | 82 pF Chip Capacitor | ATC600F820JT250XT | ATC |
| C12 | 240 pF Chip Capacitor | ATC600F241JT250XT | ATC |
| C13 | 2.2 μF Chip Capacitor | C3225X7R1H225K250AB | TDK |
| C14 | 0.1 μF Chip Capacitor | GRM21BR71H104KA01B | Murata |
| C15 | 0.01 μF Chip Capacitor | GRM21BR72A103KA01B | Murata |
| C16 | 47 pF Chip Capacitor | ATC600F470JT250XT | ATC |
| C17 | 18 pF Chip Capacitor | ATC600F180BT250XT | ATC |
| C18 | 7.5 pF Chip Capacitor | ATC100A7R5JT150XT | ATC |
| J1 | 3-pin Header | 22-28-8360 | Molex |
| L1 | 8.1 nH Inductor | 0908SQ8N1 | Coilcraft |
| L2 | 2.55 nH, 3 Turn Inductor | 0906-3JLC | Coilcraft |
| L3, L4, L5 | 21.5 nH Inductors | 0908SQ22N | Coilcraft |
| L6 | 3.85 nH, 4 Turn Inductor | 0906-4JLC | Coilcraft |
| L7 | 8.9 nH Inductor | 0806SQ8N9 | Coilcraft |
| Q1 | RF Power LDMOS Transistor | AFT09MS007NT1 | Freescale |
| R1 | 62 Ω, 1/10 W Chip Resistor | RG2012N-620-B-T1 | Susumu |
| PCB | Shengyi S1000-2, 0.020″, ε _r = 4.8 | D58008 | MTL |



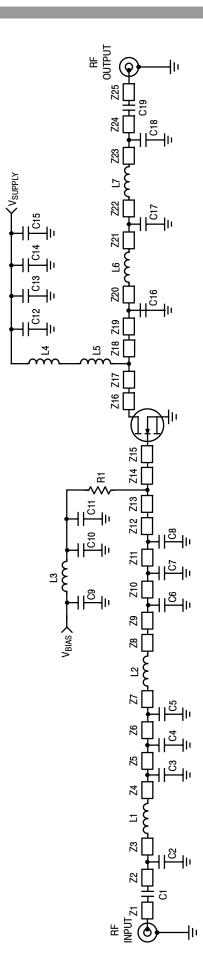


Figure 11. AFT09MS007NT1 UHF Broadband Reference Circuit Schematic — 350-470 MHz

Table 11. AFT09MS007NT1 UHF Broadband Reference Circuit Microstrips — 350-470 MHz

| Description Microstrip Description | 0.037" × 0.046" Microstrip Z18 0.088" × 0.170" Microstrip | 0.055" × 0.046" Microstrip Z19 0.205" × 0.046" Microstrip | 0.235" × 0.046" Microstrip Z20 0.148" × 0.046" Microstrip | 0.121" × 0.300" Microstrip Z21 0.032" × 0.046" Microstrip | 0.031" × 0.300" Microstrip Z22 0.195" × 0.046" Microstrip | 0.070" × 0.146" Microstrip Z23 0.089" × 0.046" Microstrip | 0.070" × 0.146" Microstrip Z24 0.046" × 0.046" Microstrip | 0.160" × 0.170" Microstrip Z25 0.060" × 0.034" Microstrip | |
|------------------------------------|---|---|---|---|---|---|---|---|----------------------------|
| | | | | | | | | | |
| Microstrip | trip Z10 | trip Z11 | trip Z12 | trip Z13 | trip Z14 | trip Z15 | trip Z16 | trip Z17 | trip |
| Description | 0.060" × 0.034" Microstrip | 0.026" × 0.046" Microstrip | 0.026" × 0.046" Microstrip | 0.060" × 0.046" Microstrip | 0.054" × 0.046" Microstrip | 0.054" × 0.046" Microstrip | 0.060" × 0.046" Microstrip | 0.084" × 0.046" Microstrip | 0.044" × 0.046" Microstrin |
| Microstrip | Z1 | Z2 | Z3 | Z4 | Z 2 | 9Z | Z2 | Z8 | 29 |



TYPICAL CHARACTERISTICS — 350–470 MHz UHF BROADBAND REFERENCE CIRCUIT

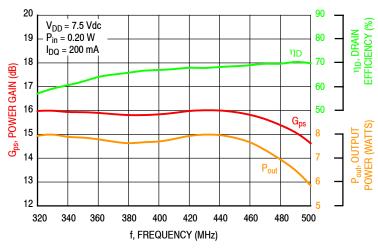


Figure 12. Power Gain, Drain Efficiency and Output Power versus Frequency at a Constant Input Power

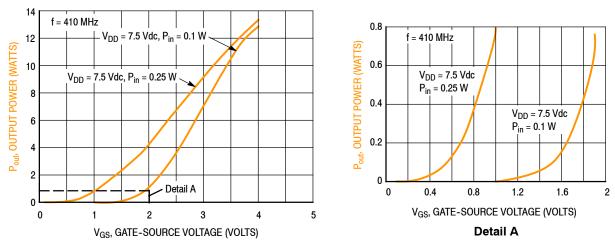


Figure 13. Output Power versus Gate-Source Voltage

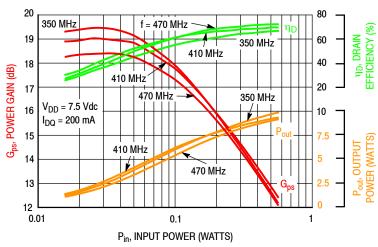
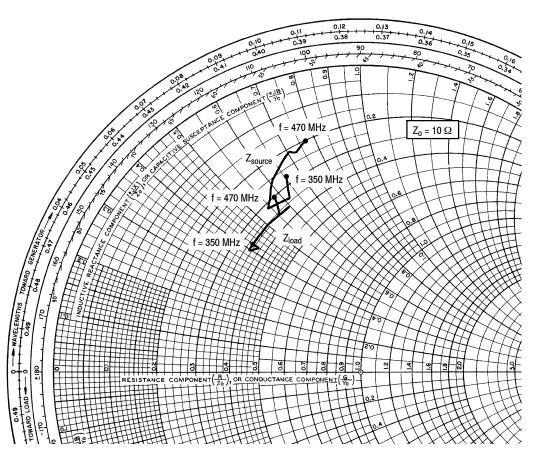


Figure 14. Power Gain, Drain Efficiency and Output Power versus Input Power and Frequency



350-470 MHz UHF BROADBAND REFERENCE CIRCUIT



 V_{DD} = 7.5 Vdc, I_{DQ} = 200 mA, P_{out} = 7.5 W

| f MHz | Z _{source} Ω | Z _{load} Ω |
|----------|--------------------------|------------------------|
| 350 | 2.7 + j6.6 | 3.5 + j4.2 |
| 370 | 3.3 + j6.2 | 3.7 + j4.2 |
| 390 | 3.1 + j5.4 | 3.5 + j4.0 |
| 410 | 2.6 + j6.1 | 3.5 + j5.0 |
| 430 | 2.1 + j7.1 | 3.6 + j5.9 |
| 450 | 2.2 + j7.3 | 3.6 + j5.6 |
| 470 | 2.0 + j7.7 | 3.0 + j5.8 |

Z_{source} = Test circuit impedance as measured from gate to ground.

 $Z_{load} \quad = \mbox{ Test circuit impedance as measured from} \\ \quad drain \mbox{ to ground.}$

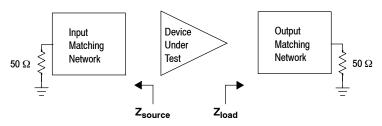


Figure 15. UHF Broadband Series Equivalent Source and Load Impedance — 350–470 MHz



450-520 MHz UHF BROADBAND REFERENCE CIRCUIT

 $\textbf{Table 12. 450-520 MHz UHF Broadband Performance} \ \, (In Freescale Reference Circuit, 50 ohm system) \\ V_{DD} = 7.5 \ \, Volts, \ \, I_{DQ} = 150 \ mA, \ \, T_{A} = 25^{\circ}C, \ \, CW \\$

| Frequency (MHz) | P _{in} (W) | G _{ps} (dB) | η _D (%) | P _{out} (W) |
|--------------------|------------------------|-------------------------|-----------------------|-------------------------|
| 450 | 0.21 | 15.4 | 57.7 | 7.5 |
| 485 | 0.21 | 15.5 | 56.0 | 7.5 |
| 520 | 0.18 | 16.2 | 66.3 | 7.5 |

Table 13. Load Mismatch/Ruggedness (In Freescale Reference Circuit)

| Frequency (MHz) | Signal Type | VSWR | P _{in} (W) | Test Voltage, V _{DD} | Result |
|--------------------|----------------|-------------------------------|-------------------------|-------------------------------|--------------------------|
| 520 | CW | > 65:1 at all Phase Angles | 0.2 (3 dB Overdrive) | 10.8 | No Device Degradation |



450-520 MHz UHF BROADBAND REFERENCE CIRCUIT

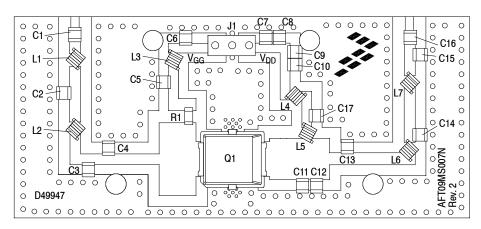


Figure 16. AFT09MS007NT1 UHF Broadband Reference Circuit Component Layout — 450-520 MHz

Table 14. AFT09MS007NT1 UHF Broadband Reference Circuit Component Designations and Values — 450-520 MHz

| Part | Description | Part Number | Manufacturer |
|---------|--|--------------------|--------------|
| C1, C16 | 100 pF Chip Capacitors | ATC600F101JT250XT | ATC |
| C2 | 7.5 pF Chip Capacitor | GQM2195C2E7R5BB12D | Murata |
| C3 | 5.6 pF Chip Capacitor | ATC600F5R6BT250XT | ATC |
| C4 | 39 pF Chip Capacitor | ATC600F390JT250XT | ATC |
| C5, C9 | 240 pF Chip Capacitors | ATC600F241JT250XT | ATC |
| C6, C7 | 0.1 μF Chip Capacitors | GRM21BR71H104KA01B | Murata |
| C8 | 0.01 μF Chip Capacitor | GRM21BR72A103KA01B | Murata |
| C10 | 2.2 μF Chip Capacitor | GRM31CR71H225KA88L | Murata |
| C11, 12 | 12 pF Chip Capacitors | ATC600F120JT250XT | ATC |
| C13 | 8.2 pF Chip Capacitor | ATC600F8R2BT250XT | ATC |
| C14 | 20 pF Chip Capacitor | ATC600F200JT250XT | ATC |
| C15 | 2 pF Chip Capacitor | ATC600F2R0BT250XT | ATC |
| C17 | 47 pF Chip Capacitor | ATC600F470JT250XT | ATC |
| J1 | 3-pin Header | 22-28-8360 | Molex |
| L1 | 2.55 nH Inductor | 0906-3JLC | Coilcraft |
| L2 | 3.85 nH Inductor | 0906-4JLC | Coilcraft |
| L3 | 22 nH Inductor | 0908SQ22N | Coilcraft |
| L4, L5 | 17 nH Inductors | 0908SQ17N | Coilcraft |
| L6 | 1.65 nH Inductor | 0906-2JLC | Coilcraft |
| L7 | 8.1 nH Inductor | 0908SQ8R1N | Coilcraft |
| R1 | 22 Ω, 1/10 W Chip Resistor | RR1220Q-220-D | Susumu |
| Q1 | RF Power LDMOS Transistor | AFT09MS007N | Freescale |
| PCB | Shengyi S1000-2, 0.020", $\varepsilon_r = 4.8$ | D49947 | MTL |



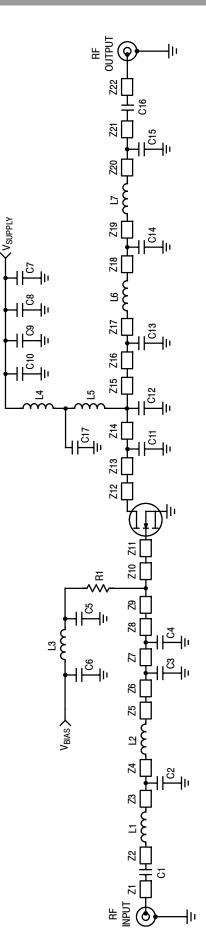


Figure 17. AFT09MS007NT1 UHF Broadband Reference Circuit Schematic — 450-520 MHz

Table 15. AFT09MS007NT1 UHF Broadband Reference Circuit Microstrips — 450-520 MHz

| Microstrip | Description | Microstrip | Description | Microstrip | Description |
|------------|----------------------------|------------|----------------------------|------------|----------------------------|
| Z1 | 0.060" × 0.034" Microstrip | 6Z | 0.121" × 0.300" Microstrip | Z16 | 0.075" × 0.049" Microstrip |
| Z2 | 0.052" × 0.046" Microstrip | Z10 | 0.031" × 0.300" Microstrip | Z17 | 0.279" × 0.049" Microstrip |
| Z3 | 0.110" × 0.046" Microstrip | Z11 | 0.070" × 0.146" Microstrip | Z18 | 0.032" × 0.046" Microstrip |
| Z4 | 0.118" × 0.046" Microstrip | Z12 | 0.070" × 0.146" Microstrip | Z19 | 0.195" × 0.046" Microstrip |
| Z5 | 0.084" × 0.046" Microstrip | Z13 | 0.138" × 0.170" Microstrip | Z20 | 0.089" × 0.046" Microstrip |
| 9Z | 0.124" × 0.046" Microstrip | Z14 | 0.055" × 0.170" Microstrip | Z21 | 0.046" × 0.046" Microstrip |
| Z2 | 0.084" × 0.046" Microstrip | Z15 | 0.055" × 0.170" Microstrip | Z22 | 0.060" × 0.034" Microstrip |
| 78 | 0.207" × 0.046" Microstrip | | | | |



TYPICAL CHARACTERISTICS — 450–520 MHz UHF BROADBAND REFERENCE CIRCUIT

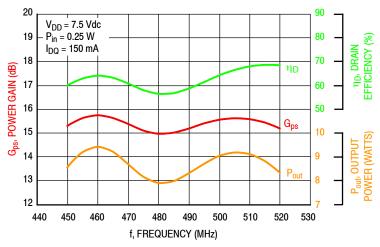


Figure 18. Power Gain, Output Power and Drain Efficiency versus Frequency at a Constant Input Power — 7.5 V

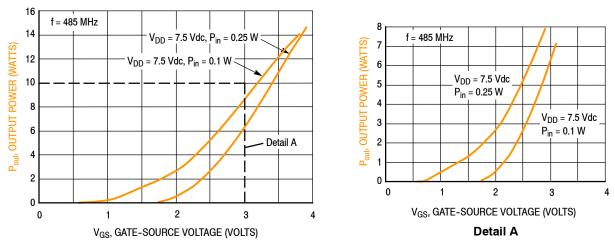


Figure 19. Output Power versus Gate-Source Voltage

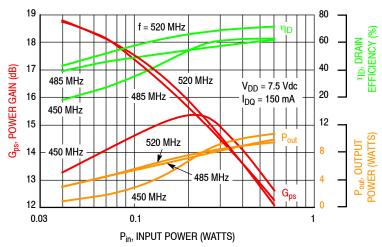
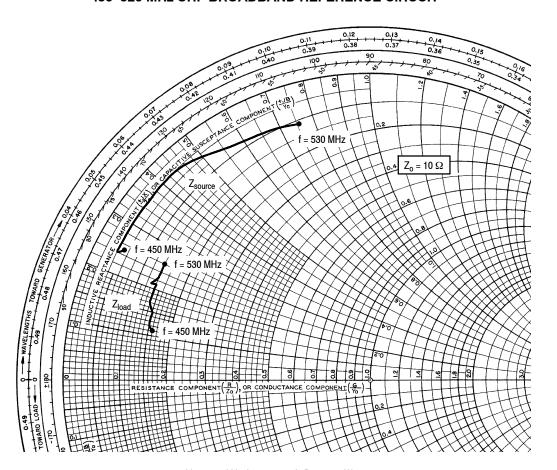


Figure 20. Power Gain, Output Power and Drain Efficiency versus Input Power and Frequency



450-520 MHz UHF BROADBAND REFERENCE CIRCUIT



 V_{DD} = 7.5 Vdc, I_{DQ} = 150 mA, P_{out} = 7.5 W

| f MHz | Z _{source} Ω | Z _{load} Ω |
|----------|--------------------------|------------------------|
| 450 | 0.45 + j2.46 | 1.56 + j1.05 |
| 460 | 0.40 + j2.37 | 1.52 + j1.24 |
| 470 | 0.40 + j2.97 | 1.46 + j1.51 |
| 480 | 0.38 + j3.56 | 1.39 + j1.71 |
| 490 | 0.41 + j4.16 | 1.35 + j2.06 |
| 500 | 0.51 + j4.79 | 1.34 + j2.06 |
| 510 | 0.70 + j5.54 | 1.37 + j2.30 |
| 520 | 0.93 + j6.44 | 1.40 + j 2.50 |
| 530 | 1.14 + j7.56 | 1.42 + j2.62 |

Z_{source} = Test circuit impedance as measured from gate to ground.

 $Z_{load} \quad = \mbox{ Test circuit impedance as measured from} \\ \quad drain to ground.$

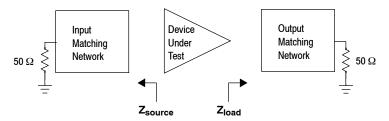


Figure 21. UHF Broadband Series Equivalent Source and Load Impedance — 450-520 MHz



760-860 MHz BROADBAND REFERENCE CIRCUIT

Table 16. 760–860 MHz Broadband Performance (In Freescale Reference Circuit, 50 ohm system)

 V_{DD} = 7.5 Volts, I_{DQ} = 150 mA, T_{A} = 25°C, CW

| Frequency (MHz) | P _{in} (W) | G _{ps} (dB) | η _D (%) | P _{out} (W) |
|--------------------|------------------------|-------------------------|-----------------------|-------------------------|
| 760 | 0.20 | 15.3 | 48.1 | 7.0 |
| 810 | 0.16 | 16.3 | 54.1 | 7.0 |
| 860 | 0.21 | 15.1 | 59.5 | 7.0 |

Table 17. Load Mismatch/Ruggedness (In Freescale Reference Circuit)

| Frequency (MHz) | Signal Type | VSWR | P _{in} (W) | Test Voltage, V _{DD} | Result |
|--------------------|----------------|-------------------------------|-------------------------|-------------------------------|--------------------------|
| 810 | CW | > 65:1 at all Phase Angles | 0.5 (3 dB Overdrive) | 9.0 | No Device Degradation |



760-860 MHz BROADBAND REFERENCE CIRCUIT

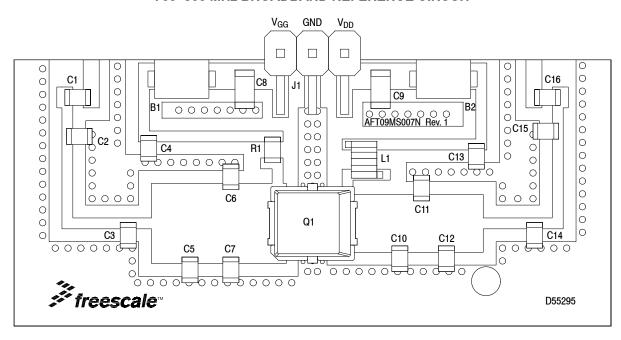


Figure 22. AFT09MS007NR1 Broadband Reference Circuit Component Layout — 760-860 MHz

Table 18. AFT09MS007NR1 Broadband Reference Circuit Component Designations and Values — 760-860 MHz

| Part | Description | Part Number | Manufacturer |
|--------------|---|--------------------|--------------|
| B1, B2 | RF Beads | 2743019447 | Fair-Rite |
| C1 | 10 pF Chip Capacitor | GQM2195C2E100FB15 | Murata |
| C2 | 3.9 pF Chip Capacitor | GQM2195C2E3R9BB15 | Murata |
| C3 | 7.5 pF Chip Capacitor | GQM2195C2E7R5BB15 | Murata |
| C4, C13, C16 | 100 pF Chip Capacitors | GQM2195C2E101GB15 | Murata |
| C5 | 8.2 pF Chip Capacitor | GQM2195C2E8R2BB15 | Murata |
| C6, C7 | 20 pF Chip Capacitors | GQM2195C2E200GB15 | Murata |
| C8 | 1 μF Chip Capacitor | GRM31MR71H105KA88L | Murata |
| C9 | 10 μF Chip Capacitor | GRM31CR61H106KA12L | Murata |
| C10, C11 | 12 pF Chip Capacitors | GQM2195C2E120FB15 | Murata |
| C12 | 5.1 pF Chip Capacitor | GQM2195C2E5R1BB15 | Murata |
| C14 | 4.7 pF Chip Capacitor | GQM2195C2E4R7BB15 | Murata |
| C15 | 3.9 pF Chip Capacitor | GQM2195C2E3R9BB15 | Murata |
| J1 | 3-pin Header | 22-28-8360 | Molex |
| L1 | 22 nH Inductor | 0908SQ-22NJL | Coilcraft |
| Q1 | RF Power LDMOS Transistor | AFT09MS007N | Freescale |
| R1 | 200 Ω Chip Resistor | CRCW0805200RJNEA | Vishay |
| PCB | Shengyi S1000-2, 0.020″, ε _r = 4.8 | D55295 | MTL |



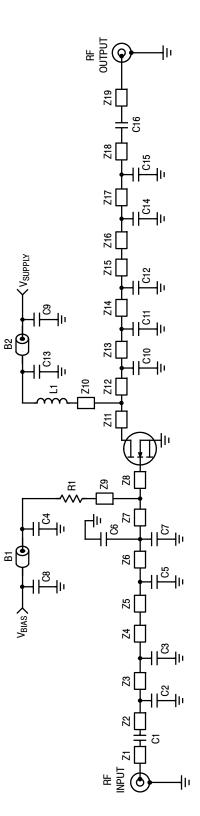


Figure 23. AFT09MS007NT1 Broadband Reference Circuit Schematic — 760–860 MHz

Table 19. AFT09MS007NT1 Broadband Reference Circuit Microstrips — 760-860 MHz

| Microstrip | Description | Microstrip | Description | Microstrip | Description |
|------------|----------------------------|------------|----------------------------|---------------|---------------------------------------|
| Z1 | 0.150" × 0.050" Microstrip | Z8 | 0.027" × 0.250" Microstrip | Z15 | 0.115" × 0.180" Micros |
| Z2 | 0.120" × 0.034" Microstrip | 6Z | 0.066" × 0.034" Microstrip | Z16 | 0.160" × 0.034" Micros |
| Z3 | 0.460" × 0.034" Microstrip | Z10 | 0.110" × 0.034" Microstrip | Z17 | 0.360" × 0.034" Micros |
| Z4 | 0.073" × 0.034" Microstrip | Z11 | 0.027" × 0.180" Microstrip | Z18 | 0.105" × 0.034" Micros |
| Z5 | 0.120" × 0.250" Microstrip | Z12 | 0.163" × 0.180" Microstrip | Z19 | 0.150" × 0.050" Micros |
| 9Z | 0.128" × 0.250" Microstrip | Z13 | 0.068" × 0.180" Microstrip | * Line length | * Line length includes microstrip ben |
| Z2 | 0.145" × 0.250" Microstrip | Z14 | 0.077" × 0.180" Microstrip | 1 | • |

ostrip ostrip ostrip ostrip ostrip



TYPICAL CHARACTERISTICS — 760–860 MHz BROADBAND REFERENCE CIRCUIT

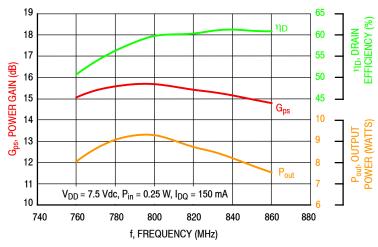


Figure 24. Power Gain, Output Power and Drain Efficiency versus Frequency at a Constant Input Power — 7.5 V

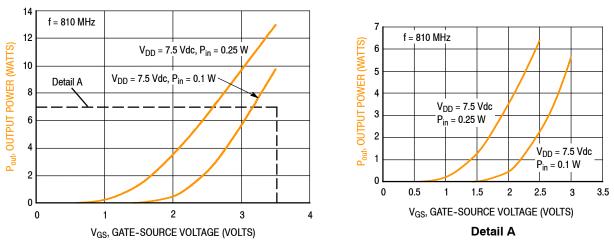


Figure 25. Output Power versus Gate-Source Voltage

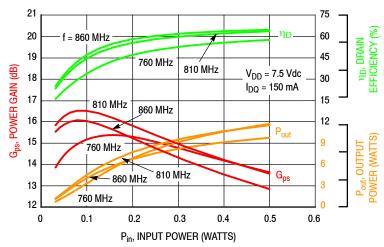
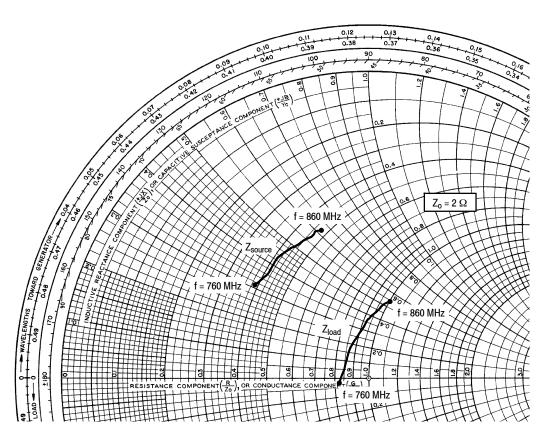


Figure 26. Power Gain, Output Power and Drain Efficiency versus Input Power and Frequency



760-860 MHz BROADBAND REFERENCE CIRCUIT



 V_{DD} = 7.5 Vdc, I_{DQ} = 150 mA, P_{out} = 7 W

| f MHz | Z _{source} Ω | Z _{load} Ω |
|----------|--------------------------|------------------------|
| 760 | 0.77 + j0.62 | 1.65 – j0.04 |
| 770 | 0.81 + j0.71 | 1.70 + j0.10 |
| 780 | 0.81 + j0.79 | 1.72 + j0.24 |
| 790 | 0.82 + j0.85 | 1.74 + j0.36 |
| 800 | 0.84 + j0.92 | 1.77 + j0.49 |
| 810 | 0.85 + j0.98 | 1.81 + j0.61 |
| 820 | 0.88 + j1.02 | 1.84 + j0.69 |
| 830 | 0.89 + j1.07 | 1.87 + 0.79 |
| 840 | 0.91 + 1.13 | 1.91 + j0.90 |
| 850 | 0.91 + j1.19 | 1.93 + j0.99 |
| 860 | 0.94 + j1.23 | 1.99 + j1.08 |

 $Z_{source} = \mbox{ Test circuit impedance as measured from } \\ \mbox{gate to ground}.$

 $Z_{load} \quad = \mbox{ Test circuit impedance as measured from} \\ \quad \mbox{ drain to ground.}$

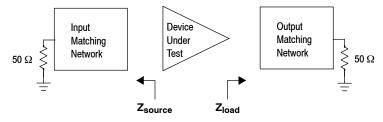


Figure 27. Broadband Series Equivalent Source and Load Impedance — 760-860 MHz



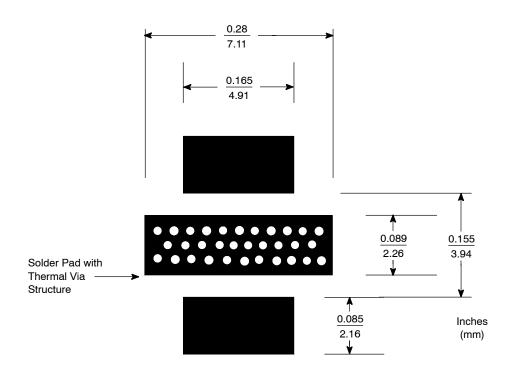


Figure 28. PCB Pad Layout for PLD-1.5W

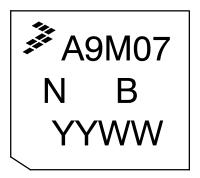
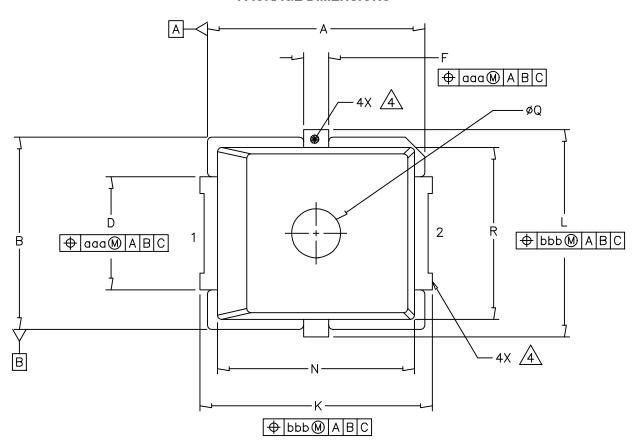
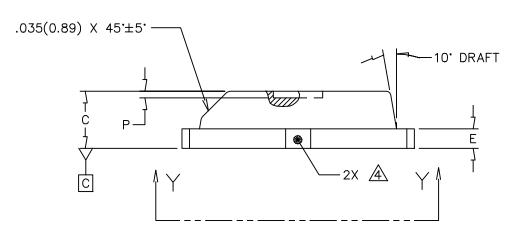


Figure 29. Product Marking



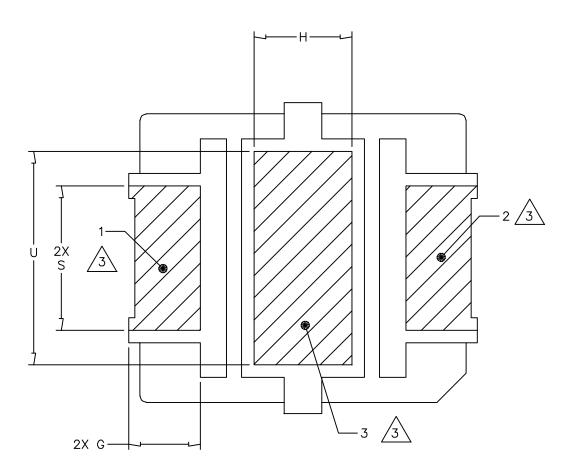
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| TITLE: | | DOCUME | NT NO: 98ASA00476D | REV: O |
| PLD-1.5W | | CASE NU | JMBER: 2297-01 | 14 JUN 2012 |
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| PLD-1.5W | | CASE NU | JMBER: 2297-01 | 14 JUN 2012 |
| | | STANDAF | RD: NON-JEDEC | |



NOTES:

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- 2. INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M-1994.



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THESE SURFACES ARE NOT PART OF THE SOLDERABLE SURFACES AND MAY REMAIN UNPLATED.

| | IN | CH | MIL | LIMETER | | | INCH | М | ILLIMETER |
|--------|------|-----------------------------|------|-----------|-------|---------|---------------|---------|-------------|
| DIM | MIN | MAX | MIN | MAX | DIM | MIN | MAX | MIN | MAX |
| Α | .255 | .265 | 6.48 | 6.73 | Q | .055 | .063 | 1.40 | 1.60 |
| В | .225 | .235 | 5.72 | 5.97 | R | .200 | .210 | 5.08 | 5.33 |
| С | .065 | .072 | 1.65 | 1.83 | S | .110 | _ | 2.79 | · – |
| D | .130 | .150 | 3.30 | 3.81 | U | .156 | _ | 3.96 | 5 – |
| E | .021 | .026 | 0.53 | 0.66 | aaa | | .004 | | 0.10 |
| F | .026 | .044 | 0.66 | 1.12 | bbb | | .005 | | 0.13 |
| G | .038 | _ | 0.97 | _ | | | | | |
| Н | .069 | _ | 1.75 | _ | | | | | |
| J | .160 | .180 | 4.06 | 4.57 | | | | | |
| K | .273 | .285 | 6.93 | 7.24 | | | | | |
| L | .245 | .255 | 6.22 | 6.48 | | | | | |
| N | .230 | .240 | 5.84 | 6.10 | | | | | |
| Р | .000 | .008 | 0.00 | 0.20 | | | | | |
| © F | | MICONDUCTOR, S RESERVED. | INC. | MECHANICA | L OUT | LINE | PRINT VERS | SION NO | T TO SCALE |
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| | | PLD-1. | 5W | | | CASE NL | JMBER: 2297—0 |)1 | 14 JUN 2012 |
| | | | | | | STANDAF | RD: NON-JEDEC | ; | |



PRODUCT DOCUMENTATION, SOFTWARE AND TOOLS

Refer to the following documents, software and tools to aid your design process.

Application Notes

• AN1955: Thermal Measurement Methodology of RF Power Amplifiers

Engineering Bulletins

• EB212: Using Data Sheet Impedances for RF LDMOS Devices

Software

- Electromigration MTTF Calculator
- RF High Power Model
- .s2p File

Development Tools

· Printed Circuit Boards

For Software and Tools, do a Part Number search at http://www.freescale.com, and select the "Part Number" link. Go to the Software & Tools tab on the part's Product Summary page to download the respective tool.

REVISION HISTORY

The following table summarizes revisions to this document.

| Date | Description |
|---------------------|--|
| June 2013 | Initial Release of Data Sheet |
| June 2013 Apr. 2014 | Initial Release of Data Sheet Wideband Performance tables 8, 12, 16: updated to include P_{in} for all reference circuits, pp. 1, 8, 13, 18 Tape and Reel information: corrected tape width information from 13-inch reel to 7-inch reel to reflect actual reel size, p. 1 Maximum Ratings table: changed Total Device Dissipation value from 182 to 114 W to reflect performance at 150°C, p. 2 Fig. 4, MTTF versus Junction Temperature – CW: MTTF end temperature on graph changed to match maximum operating junction temperature, p. 4 Table 6, Test Circuit Component Designations and Values: updated PCB description to reflect most current board specifications from Rogers, p. 5 Added 350–470 MHz UHF Broadband Reference Circuit as follows: - Wideband Performance table, p. 1 - Table 8, UHF Broadband Performance, p. 8 - Table 9, Load Mismatch/Ruggedness, p. 8 - Fig. 10, UHF Broadband Reference Circuit Component Layout, p. 9 - Table 10, UHF Broadband Reference Circuit Component Designations and Values, p. 9 - Fig. 11, UHF Broadband Reference Circuit Schematic, p. 10 - Table 11, UHF Broadband Reference Circuit Microstrips, p. 10 - Fig. 12, Power Gain, Drain Efficiency and Output Power versus Frequency at a Constant Input Power, p. 11 - Fig. 13, Output Power versus Gate–Source Voltage, p. 11 |
| | Fig. 14, Power Gain, Drain Efficiency and Output Power versus Input Power and Frequency, p. 11 Fig. 15, VHF Broadband Series Equivalent Source and Load Impedance, p. 12 Table 12. Load Mismatch/Ruggedness table: changed Test Voltage from 9.0 to 10.8 Vdc to reflect true capability of the circuit, p. 13 |
| | June 2013 |



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